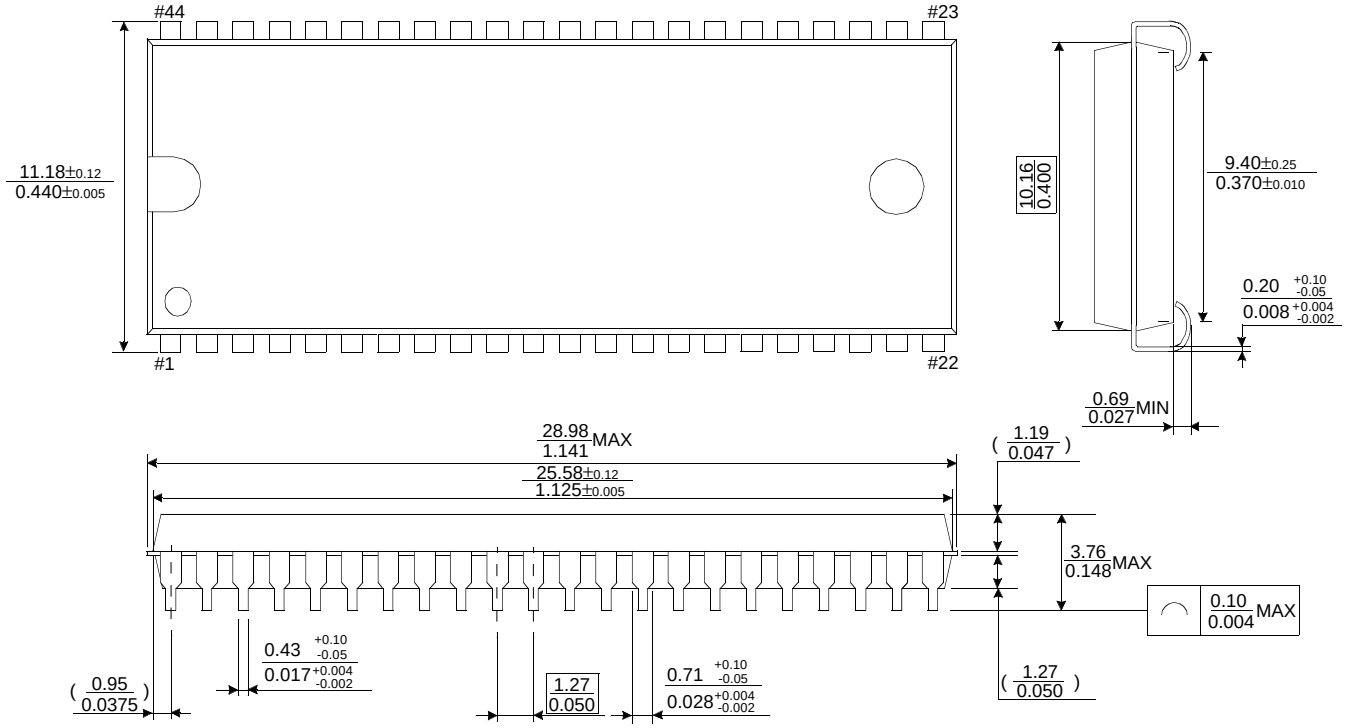
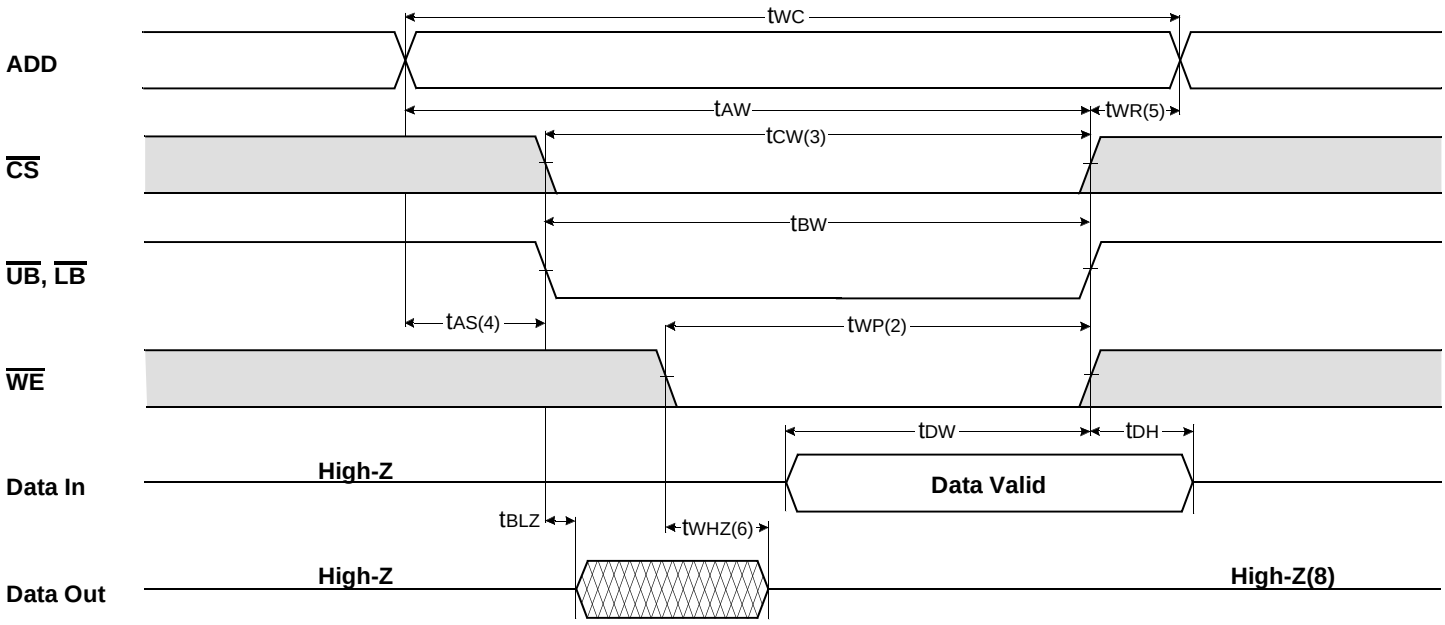
PACKAGE DIMENSIONS

44-SOJ-400

Units : Inches (millimeters)



TIMING WAVE FORM OF WRITE CYCLE(4) ($\overline{UB}$, $\overline{LB}$ Controlled)



NOTES(WRITE CYCLE)

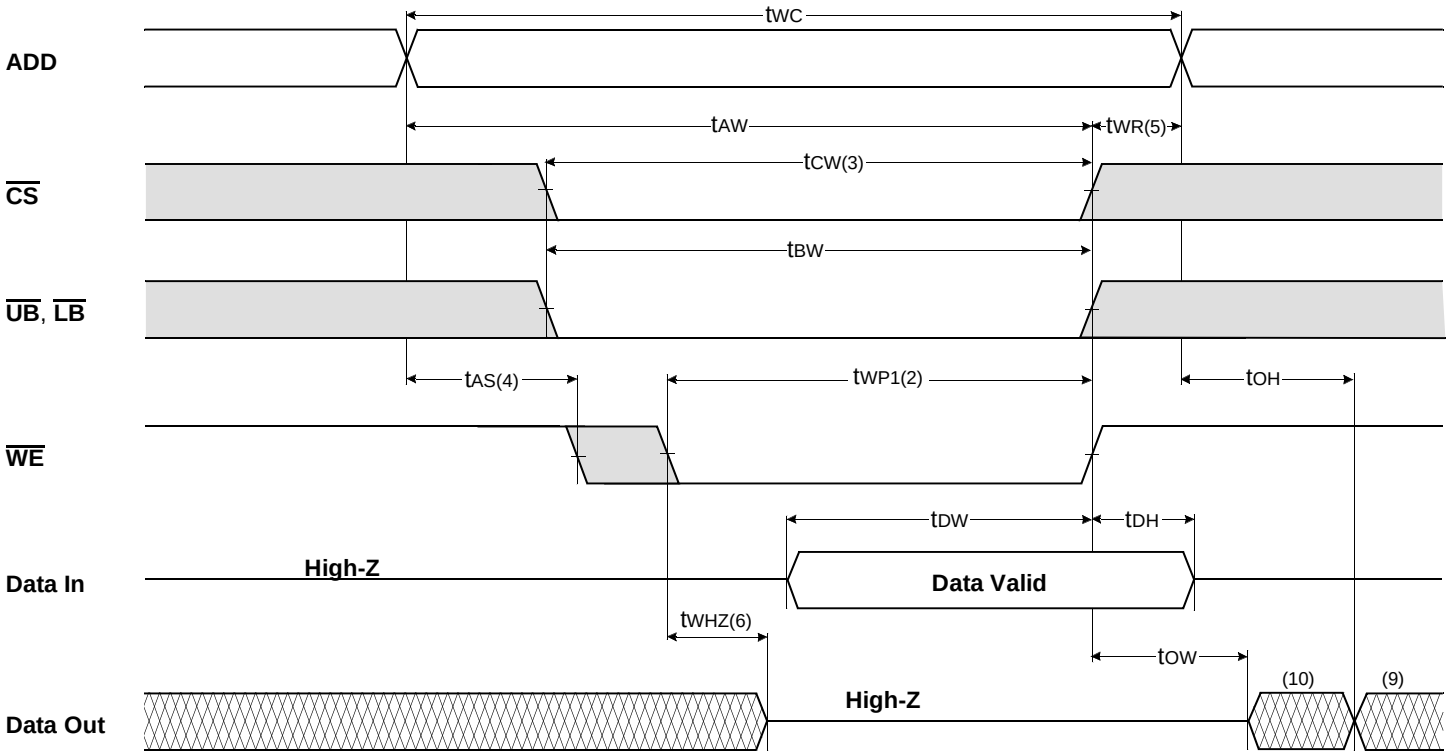
1. All write cycle timing is referenced from the last valid address to the first transition address.
2. A write occurs during the overlap of a low $\overline{CS}$,$\overline{WE}$,$\overline{LB}$ and $\overline{UB}$. A write begins at the latest transition $\overline{CS}$ going low and $\overline{WE}$ going low ; A write ends at the earliest transition $\overline{CS}$ going high or $\overline{WE}$ going high. t_{WP} is measured from the beginning of write to the end of write.
3. t_{CW} is measured from the later of $\overline{CS}$ going low to end of write.
4. t_{AS} is measured from the address valid to the beginning of write.
5. t_{WR} is measured from the end of write to the address change. t_{WR} applied in case a write ends as $\overline{CS}$, or $\overline{WE}$ going high.
6. If $\overline{OE}$. $\overline{CS}$ and $\overline{WE}$ are in the Read Mode during this period, the I/O pins are in the output low-Z state. Inputs of opposite phase of the output must not be applied because bus contention can occur.
7. For common I/O applications, minimization or elimination of bus contention conditions is necessary during read and write cycle.
8. If $\overline{CS}$ goes low simultaneously with $\overline{WE}$ going or after $\overline{WE}$ going low, the outputs remain high impedance state.
9. Dout is the read data of the new address.
10. When $\overline{CS}$ is low : I/O pins are in the output state. The input signals in the opposite phase leading to the output should not be applied.

FUNCTIONAL DESCRIPTION

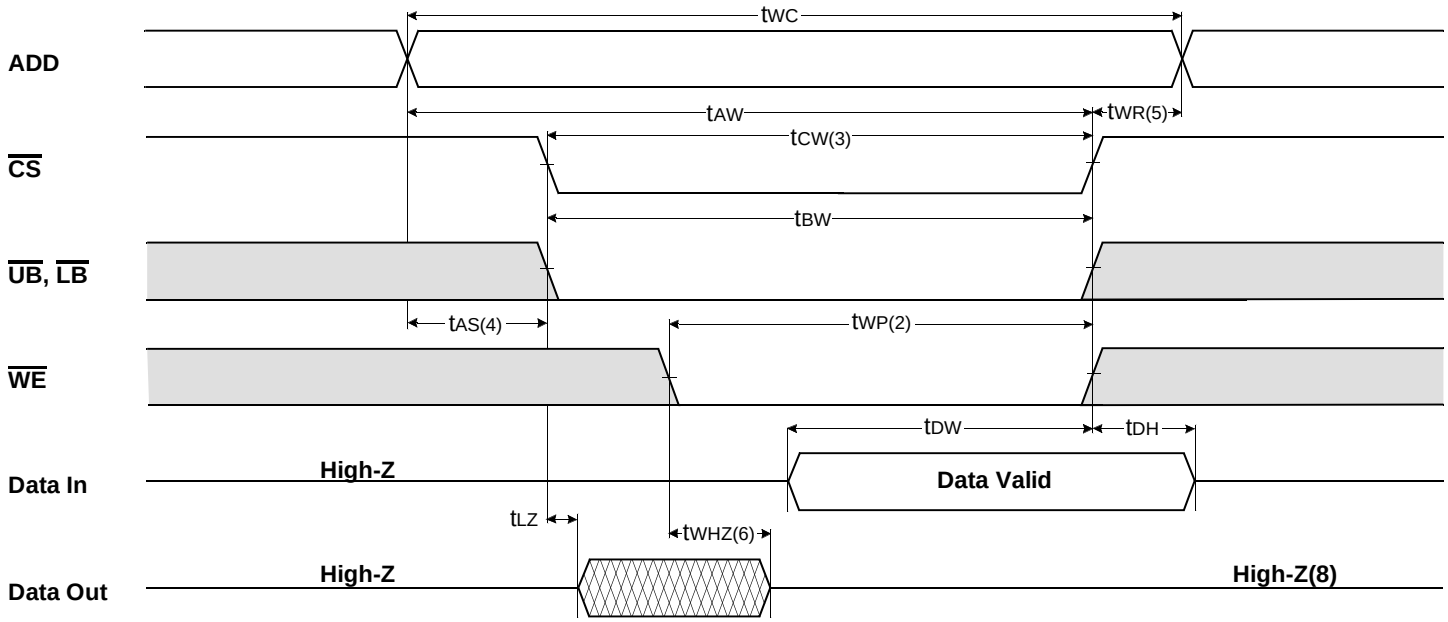
$\overline{CS}$	$\overline{WE}$	$\overline{OE}$	$\overline{LB}$	$\overline{UB}$	Mode	I/O Pin		Supply Current
						I/O_1~I/O_8	I/O_9~I/O_{16}	
H	X	X*	X	X	Not Select	High-Z	High-Z	I_{SB}, I_{SB1}
L	H	H	X	X	Output Disable	High-Z	High-Z	I_{CC}
L	X	X	H	H				
L	H	L	L	H	Read	D_{OUT}	High-Z	I_{CC}
			H	L		High-Z	D_{OUT}	
			L	L		D_{OUT}	D_{OUT}	
L	L	X	L	H	Write	D_{IN}	High-Z	I_{CC}
			H	L		High-Z	D_{IN}	
			L	L		D_{IN}	D_{IN}	

* NOTE : X means Don't Care.

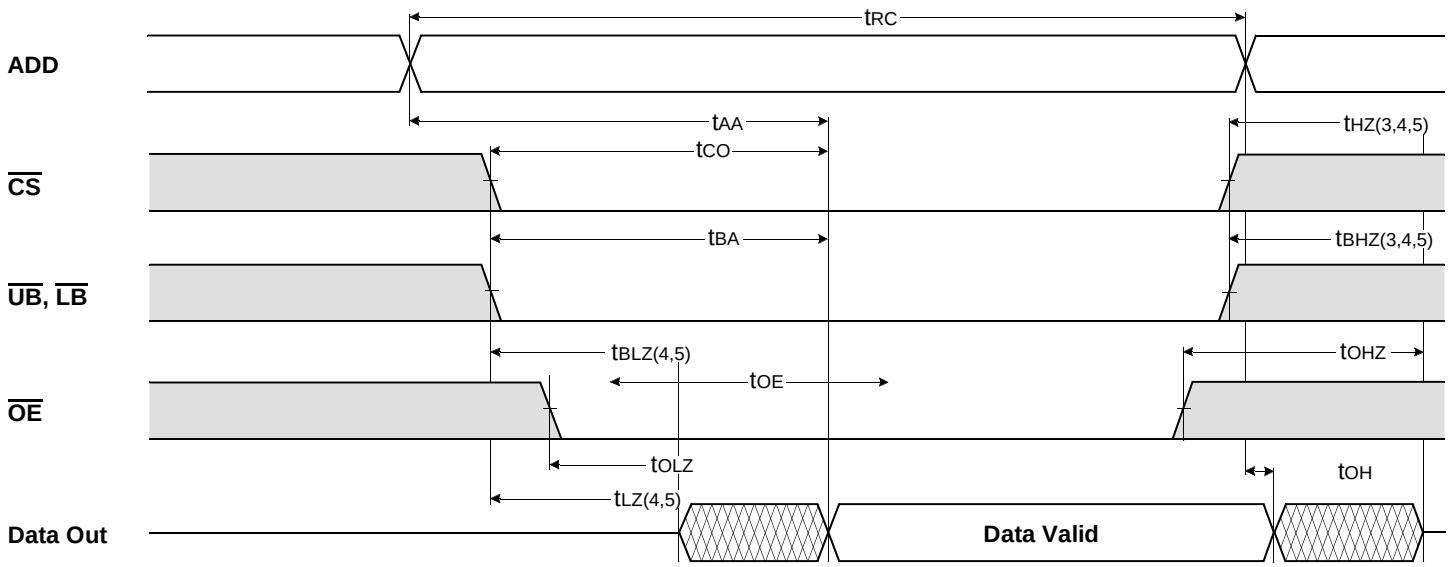
TIMING WAVE FORM OF WRITE CYCLE(2) ($\overline{OE}$=Low Fixed)



TIMING WAVE FORM OF WRITE CYCLE(3) ($\overline{CS}$=Controlled)



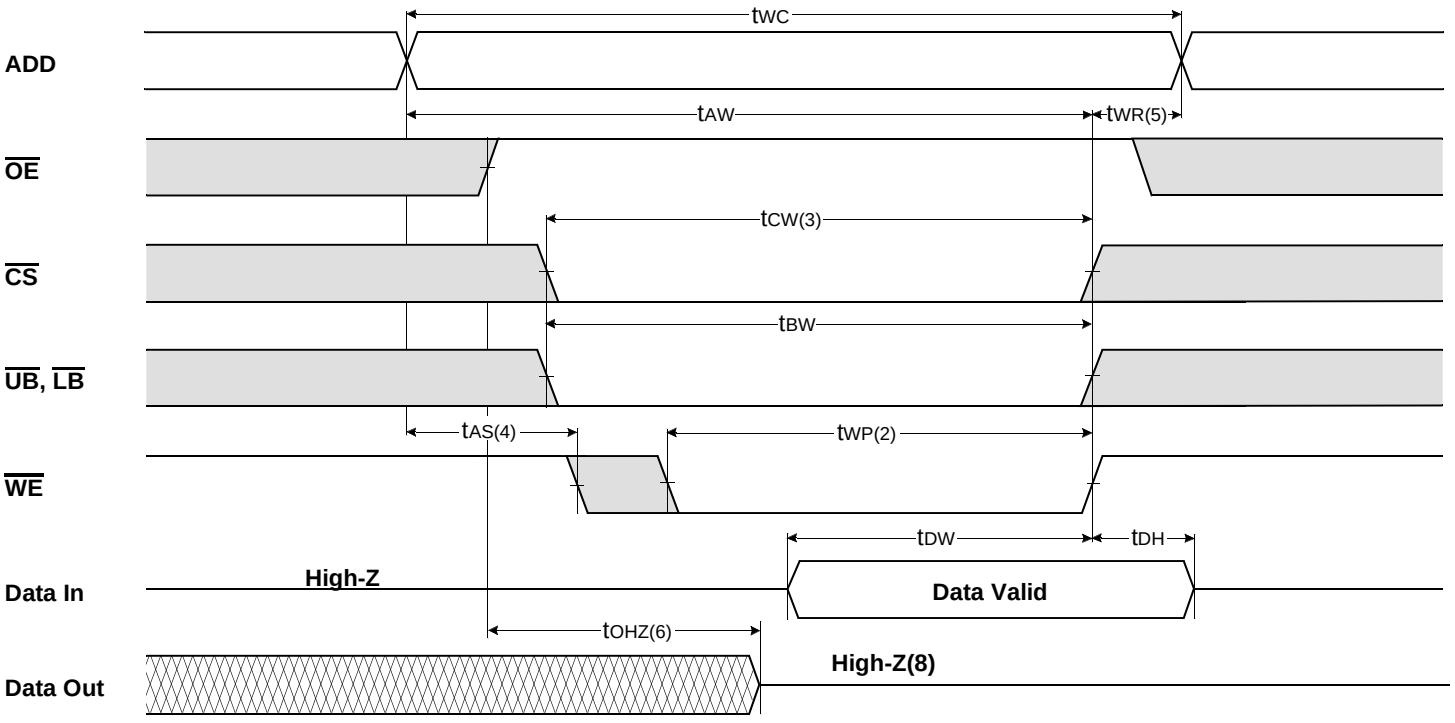
TIMING WAVE FORM OF READ CYCLE(2)($\overline{WE}$=V_{IH})



NOTES(READ CYCLE)

1. $\overline{WE}$ is high for read cycle.
2. All read cycle timing is referenced from the last valid address to the first transition address.
3. t_{HZ} and t_{OHZ} are defined as the time at which the outputs achieve the open circuit condition and are not referenced to V_{OH} or V_{OL} Levels.
4. At any given temperature and voltage condition, t_{HZ}(Max.) is less than t_{LZ} (Min.) both for a given device and from device to device.
5. Transition is measured ±200§Æ from steady state voltage with Load(B). This parameter is sampled and not 100% tested.
6. Device is continuously selected with $\overline{CS}$=V_{IL}.
7. Address valid prior to coincident with $\overline{CS}$ transition low.
8. For common I/O applications, minimization or elimination of bus contention conditions is necessary during read and write cycl e.

TIMING WAVE FORM OF WRITE CYCLE(1)($\overline{OE}$=Clock)



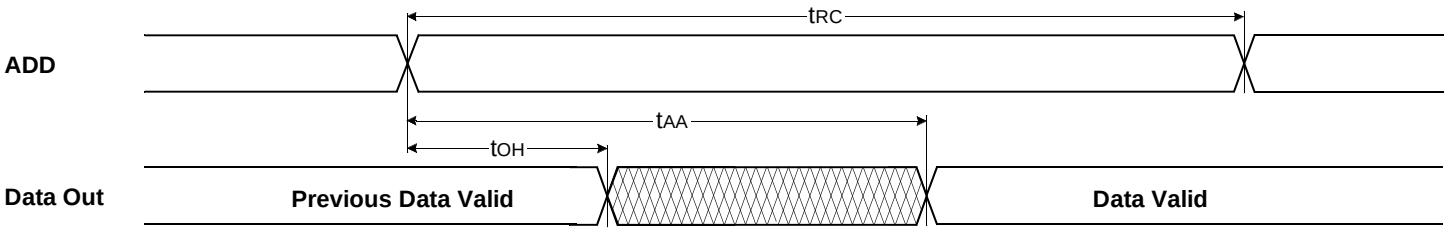
WRITE CYCLE

Parameter	Symbol	KM6164002-20		KM6164002-25		Unit
		Min	Max	Min	Max	
Write Cycle Time	t_{WC}	20	-	25	-	§À
Chip Select to End of Write	t_{CW}	15	-	17	-	§À
Address Set-up Time	t_{AS}	0	-	0	-	§À
Address Valid to End of Write	t_{AW}	15	-	17	-	§À
Write Pulse Width($\overline{OE}$ High)	t_{WP}	15	-	17	-	§À
Write Pulse Width($\overline{OE}$ Low)	t_{WP1}	20	-	25	-	§À
$\overline{UB}$, $\overline{LB}$ Valid to End of Write	t_{BW}	15	-	17	-	ns
Write Recovery Time	t_{WR}	0	-	0	-	§À
Write to Output High-Z	t_{WHZ}	0	8	0	8	§À
Data to Write Time Overlap	t_{DW}	10	-	12	-	§À
Data Hold from Write Time	t_{DH}	0	-	0	-	§À
End Write to Output Low-Z	t_{OW}	3	-	4	-	§À

NOTE: Above parameters are also guaranteed at extended and industrial temperature ranges.

TIMING DIAGRAMS

TIMING WAVE FORM OF READ CYCLE(1) (Address Controlled, $\overline{CS}$=$\overline{OE}$=$\overline{UB}$=$\overline{LB}$=V_{IL}, $\overline{WE}$=V_{IH})



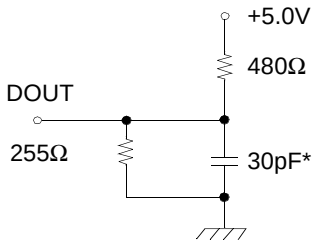
AC CHARACTERISTICS(T_A=0 to 70°C, V_{CC}=5.0V±10%, unless otherwise noted.)

TEST CONDITIONS

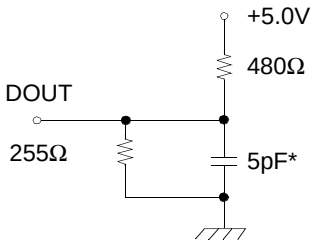
Parameter	Value
Input Pulse Levels	0V to 3V
Input Rise and Fall Times	3§À
Input and Output timing Reference Levels	1.5V
Output Loads	See below

NOTE: Above test conditions are also applied at extended and industrial temperature ranges .

Output Loads(A)



Output Loads(B)
for t_{HZ}, t_{LZ}, t_{WHZ}, t_{OW}, t_{OLZ} & t_{OHZ}



* Including Scope and Jig Capacitance

READ CYCLE

Parameter	Symbol	KM6164002-20		KM6164002-25		Unit
		Min	Max	Min	Max	
Read Cycle Time	t_{RC}	20	-	25	-	§À
Address Access Time	t_{AA}	-	20	-	25	§À
Chip Select to Output	t_{CO}	-	20	-	25	§À
Output Enable to Valid Output	t_{OE}	-	10	-	12	§À
$\overline{UB}$, $\overline{LB}$ Access Time	t_{BA}	-	10	-	12	ns
Chip Enable to Low-Z Output	t_{LZ}	5	-	5	-	§À
Output Enable to Low-Z Output	t_{OLZ}	0	-	0	-	§À
$\overline{UB}$, $\overline{LB}$ Enable to Low-Z Output	t_{BLZ}	0	-	0	-	ns
Chip Disable to High-Z Output	t_{HZ}	0	7	0	8	§À
Output Disable to High-Z Output	t_{OHZ}	0	7	0	8	§À
$\overline{UB}$, $\overline{LB}$ Disable to High-Z Output	t_{BHZ}	0	7	0	8	ns
Output Hold from Address Change	t_{OH}	4	-	5	-	§À

NOTE: Above parameters are also guaranteed at extended and industrial temperature ranges.

ABSOLUTE MAXIMUM RATINGS*

Parameter		Symbol	Rating	Unit
Voltage on Any Pin Relative to V_{SS}		V_{IN}, V_{OUT}	-0.5 to 7.0	V
Voltage on V_{CC} Supply Relative to V_{SS}		V_{CC}	-0.5 to 7.0	V
Power Dissipation		P_D	1.0	W
Storage Temperature		T_{STG}	-65 to 150	°C
Operating Temperature	Commercial	T_A	0 to 70	°C
	Extended	T_A	-25 to 85	°C
	Industrial	T_A	-40 to 85	°C

***** Stresses greater than those listed under "Absolute Maximum Rating" may cause permanent damage to the device. This is a stress ra ting only and functional operation of the device at these at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

RECOMMENDED DC OPERATING CONDITIONS(T_A=0 to 70°C)

Parameter	Symbol	Min	Typ	Max	Unit
Supply Voltage	V_{CC}	4.5	5.0	5.5	V
Ground	V_{SS}	0	0	0	V
Input Low Voltage	V_{IH}	2.2	-	V_{CC}+0.5**	V
Input Low Voltage	V_{IL}	-0.5*	-	0.8	V

NOTE: Above parameters are also guaranteed at extended and industrial temperature ranges.

* V_{IL}(Min) = -2.0V a.c(Pulse Width ≤10ns) for I≤20§Ì

** V_{IH}(Max) = V_{CC} + 2.0V a.c (Pulse Width ≤10ns) for I≤20§Ì

DC AND OPERATING CHARACTERISTICS(T_A=0 to 70°C, Vcc=5.0V±10%, unless otherwise specified)

Parameter	Symbol	Test Conditions		Min	Max	Unit
Input Leakage Current	I_{LI}	V_{IN} = V_{SS} to V_{CC}		-2	2	µA
Output Leakage Current	I_{LO}	$\overline{CS}$=V_{IH} or $\overline{OE}$=V_{IH} or $\overline{WE}$=V_{IL} V_{OUT} = V_{SS} to V_{CC}		-2	2	µA
Operating Current	I_{CC}	Min. Cycle, 100% Duty $\overline{CS}$=V_{IL}, V_{IN} = V_{IH} or V_{IL}, I_{OUT}=0mA	20ns	-	240	§Ì
			25ns	-	220	
Standby Current	I_{SB}	Min. Cycle, $\overline{CS}$=V_{IH}		-	60	§Ì
	I_{SB1}	f=0MHz, $\overline{CS}$≥V_{CC}-0.2V, V_{IN}≥V_{CC}-0.2V or V_{IN}≤0.2V		-	10	§Ì
Output Low Voltage Level	V_{OL}	I_{OL}=8mA		-	0.4	V
Output High Voltage Level	V_{OH}	I_{OH}=-4mA		2.4	-	V
	V_{OH1}*	I_{OH1}=-0.1mA		-	3.95	V

NOTE: Above parameters are also guaranteed at extended and industrial temperature ranges.

* V_{CC}=5.0V±5% Temp. = 25°C

CAPACITANCE*(T_A=25°C, f=1.0MHz)

Item	Symbol	Test Conditions	MIN	Max	Unit
Input/Output Capacitance	$C_{I/O}$	$V_{I/O}$=0V	-	8	pF
Input Capacitance	C_{IN}	V_{IN}=0V	-	6	pF

* NOTE : Capacitance is sampled and not 100% tested.

256K x 16 Bit High-Speed CMOS Static RAM

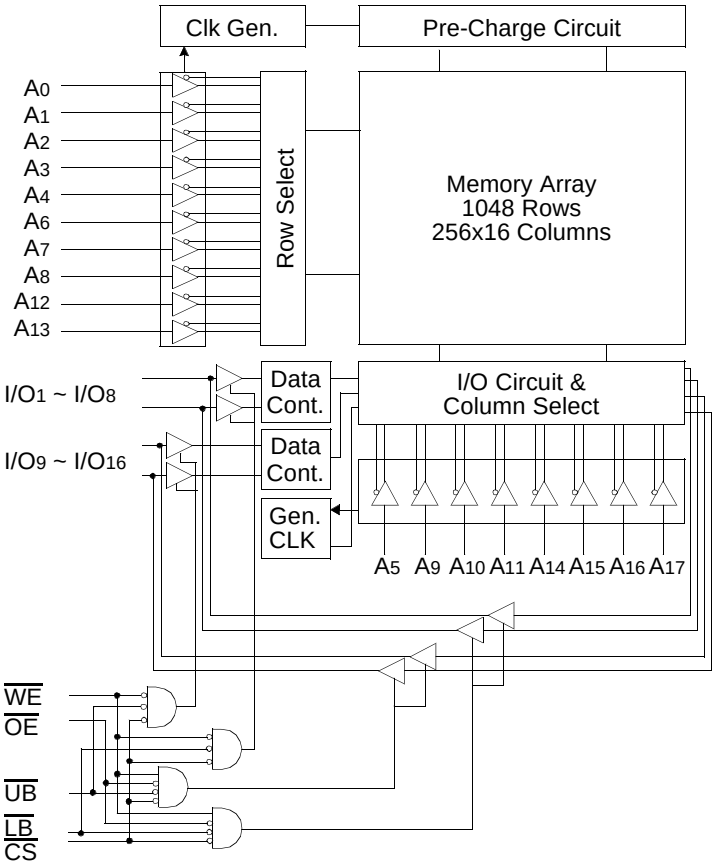
FEATURES

- Fast Access Time 20,25§À(Max.)
- Low Power Dissipation
  - Standby (TTL) : 60§Ì(Max.)
  - CMOS) : 10§Ì(Max.)
  - Operating KM6164002 - 20 : 240§Ì(Max.)
  - KM6164002 - 25 : 220§Ì(Max.)
- Single 5.0V±10% Power Supply
- TTL Compatible Inputs and Outputs
- I/O Compatible with 3.3V Device
- Fully Static Operation
  - No Clock or Refresh required
- Three State Outputs
- Center Power/Ground Pin Configuration
- Data Byte Control : $\overline{LB}$: I/O1~ I/O8, $\overline{UB}$: I/O9~ I/O16
- Standard Pin Configuration
  - KM6164002J : 44-SOJ-400

ORDERING INFORMATION

KM6164002 -20/25	Commercial Temp.
KM6164002E -20/25	Extended Temp.
KM6164002I -20/25	Industrial Temp.

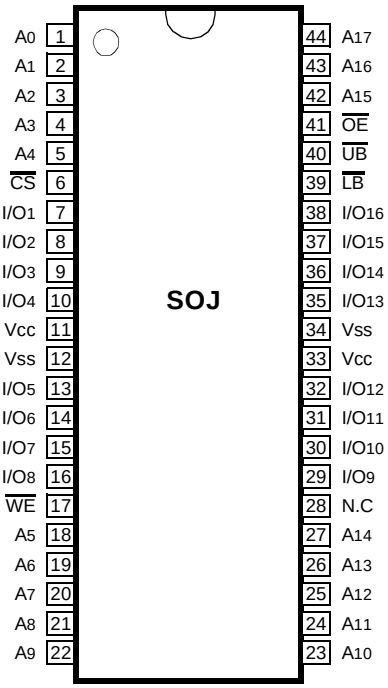
FUNCTIONAL BLOCK DIAGRAM



GENERAL DESCRIPTION

The KM6164002 is a 4,194,304-bit high-speed Static Random Access Memory organized as 262,144 words by 16 bits. The KM6164002 uses 16 common input and output lines and has an output enable pin which operates faster than address access time at read cycle. Also it allows that lower and upper byte access by data byte control ($\overline{UB}$, $\overline{LB}$). The device is fabricated using SAMSUNG's advanced CMOS process and designed for high-speed circuit technology. It is particularly well suited for use in high-density high-speed system applications. The KM6164002 is packaged in a 400mil 44-pin plastic SOJ.

PIN CONFIGURATION *(Top View)*



PIN FUNCTION

Pin Name	Pin Function
A0 - A17	Address Inputs
$\overline{WE}$	Write Enable
$\overline{CS}$	Chip Select
$\overline{OE}$	Output Enable
$\overline{LB}$	Lower-byte Control(I/O1~I/O8)
$\overline{UB}$	Upper-byte Control(I/O9~I/O16)
I/O1 ~ I/O16	Data Inputs/Outputs
Vcc	Power(+5.0V)
Vss	Ground

Document Title

64Kx16 Bit High Speed Static RAM(5V Operating), Revolutionary Pin out. Operated at Commercial, Extended and Industrial Temperature Range.

Revision History

Rev No.	History	Draft Data	Remark
Rev. 0.0	Initial release with Preliminary.	Jun. 1th, 1991	Preliminary
Rev. 1.0	Release to final Data Sheet. 1.1. Delete Preliminary	Oct. 4th, 1993	Final
Rev. 2.0	2.1.Delete Low power product with Data Retention Mode. 2.1.1. Delete Data Retention Characteristics 2.2.Add Industrial and Extended Temperature Range parts with the same parameters as Commercial Temperature Range parts. 2.2.1 Add KM6164002I for Industrial Temperature Range. 2.2.2.Add KM6164002E for Extended Temperature Range. 2.2.3.Add ordering information. 2.2.4. Add the condition for operating at Industrial and Extended Temperature Range. 2.3.Add timing diagram to define t_{WP1} as ″(**Timing Wave Form of Write Cycle($\overline{OE}$=Low fixed)**″ 2.4.Delete 35ns part.	Jun. 17th, 1997	Final